

Part Number: KB814-B

Features

- 1.AC input.
- 2.High isolation voltage between input and output (Viso=5000 Vrms).
- 3.Compact dual-in-line package KB814-B:1-channel type.
- 4.Recognized by UL and CUL, file NO.E225308.
- 5.Approved by VDE 0884 Teil2(NO:40006364) (Creepage distance between input and output:7mm or more).
- 6.Moisture Sensitivity Level : Level 4.
- 7.RoHS compliant.

DESCRIPTION

- 1.The KB814-B is optically coupled isolators containing two GaAS light emitting diode and an NPN silicon phototransistor.
- 2.The lead pitch is 2.54mm.

APPLICATIONS

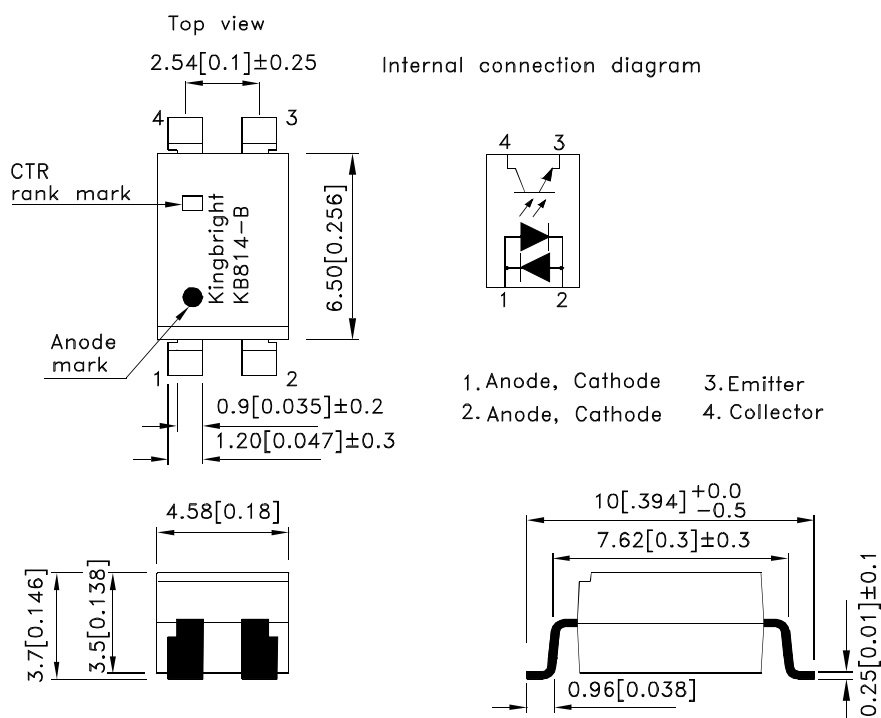
- 1.Computer terminals.
- 2.Registers,copiers,automatic vending machines.
- 3.System appliances, measuring instruments.
- 4.Programmable logic controller.
- 5.Signal transmission between circuits of different potentials and impedances.



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*PACKAGE DIMENSIONS (UNIT:mm)

Lead Bending Type



TOLERANCE : ±0.5[±0.02] UNLESS OTHERWISE NOTED.

* Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Rating	Unit
Input	Forward current	IF	± 50	mA
	Power dissipation	P	70	mW
Output	Collector-emitter voltage	V _{CEO}	35	V
	Emitter-collector voltage	V _{ECO}	6	V
	Collector current	I _C	50	mA
	Collector power dissipation	P _C	150	mW
Total power dissipation		P _{tot}	200	mW
*1 Isolation voltage		Viso	5000	V _{r.m.s}
Operating temperature		T _{opr}	-30~+100	V _{rms}
Storage temperature		T _{stg}	-55~+125	° C
*2 Soldering temperature		T _{sol}	260	° C

*1 40 to 60%RH, AC for 1 minute

*2 For 10 seconds

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* Electro-optical Characteristics

Parameter			Symbol	Conditions	Min.	Typ.	Max.	Unit
Input	Forward voltage		V_F	$I_F=\pm 20\text{mA}$	—	1.2	1.4	V
	Peak forward voltage		V_{FM}	$I_{FM}=\pm 0.5\text{A}$	—	—	3.0	V
Output	Collector dark current		I_{CEO}	$V_{CE}=20\text{V}, I_F=0\text{mA}$	—	—	10^{-7}	A
Transfer charact- eristics	*1 Current transfer ratio		CTR	$I_F=\pm 1\text{mA}, V_{CE}=5\text{V}$	20	—	300	%
	Collector-emitter saturation voltage		$V_{CE(\text{Sat})}$	$I_F=\pm 20\text{mA}, I_C=1\text{mA}$	—	0.1	0.2	V
	Response time	Rise time	t_r	$V_{CE}=2\text{V}, I_C=2\text{mA}$ $R_L=100\Omega$	—	4	18	μS
		Fall time	t_f		—	3	18	μS

*1 Classification table of current transfer ratio is shown below.

$$\text{CTR} = \frac{I_C}{I_F} \times 100\%$$

Model NO.	Rank mark	CTR (%)
KB814L-B	L	20~60
KB814A-B	A	50~150
KB814B-B	B	120~300
KB814LA-B	L or A	20~150
KB814AB-B	A or B	50~300
KB814-B	L, A, B or No mark	20~300

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Fig. 1 Current Transfer Ratio vs. Forward Current

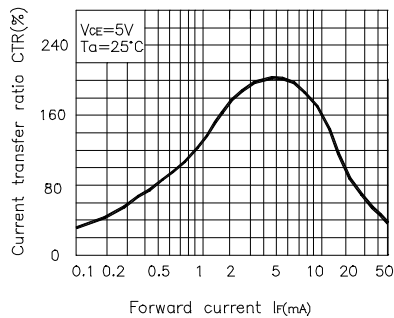


Fig. 2 Forward Current vs. Forward voltage

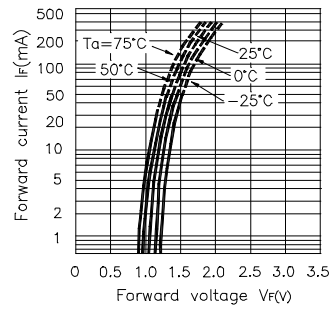


Fig. 3 Collector Current vs. Collector-emitter Voltage

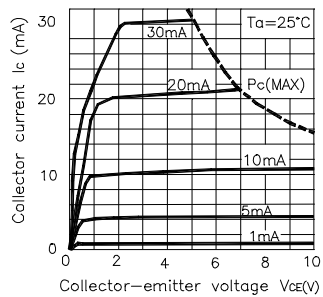


Fig. 4 Relative Current Transfer Ratio vs. Ambient Temperature

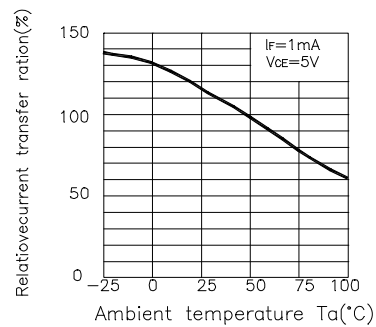


Fig. 5 Collector-emitter Saturation Voltage vs. Ambient Temperature

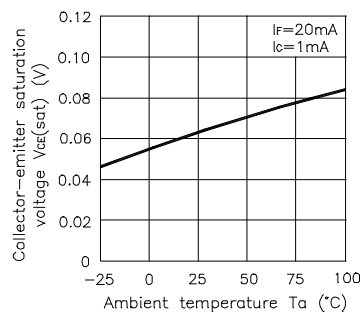
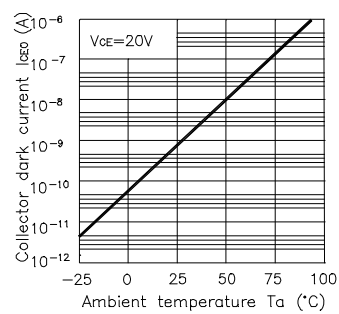


Fig. 6 Collector Dark Current vs. Ambient Temperature



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Fig. 7 Forward Current vs. Ambient Temperature

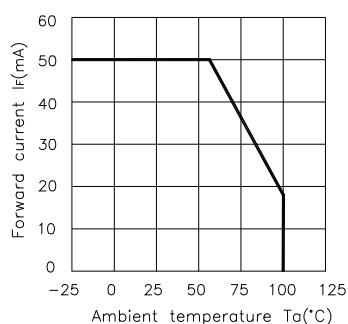


Fig. 8 Collector Power Dissipation vs. Ambient Temperature

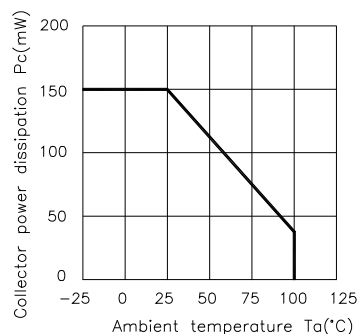
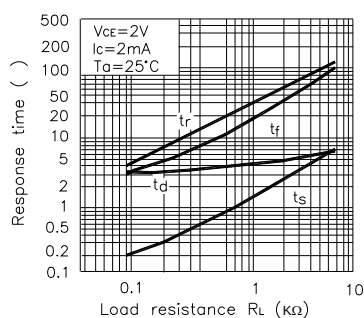


Fig. 9 Response Time vs. Load Resistance



Test Circuit for Response Time

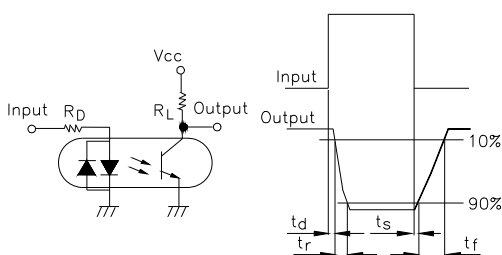
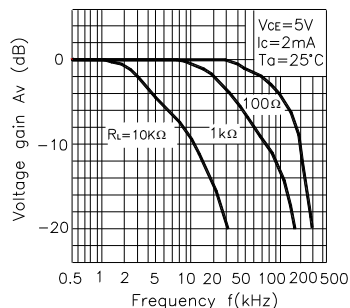


Fig. 10 Frequency Response



Test Circuit for Frequency Response

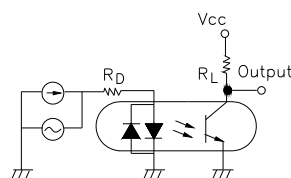
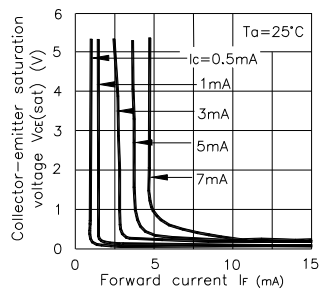


Fig. 11 Collector-emitter Saturation Voltage vs. Forward Current



* NOTES ON HANDLING

1.Recommended soldering conditions (Dip soldering)

(1) Dip soldering

Temperature	260 °C or below (molten solder temperature)
Time	Less than 10 seconds.
Cycle	One cycle allowed to be dipped in solder including plastic nold portion.
Flux	Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

(2) Cautions

Fluxes

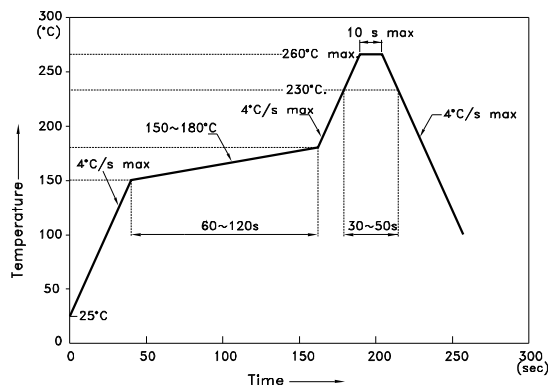
Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2.Cautions regarding noise

Be aware that power is suddenly into the component any surge current may cause damage happen, even if the voltage is within the absolute maximum ratings.

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Reflow Soldering Profile For Lead-free SMT Process.



NOTES:

1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

CAUTION

Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested.

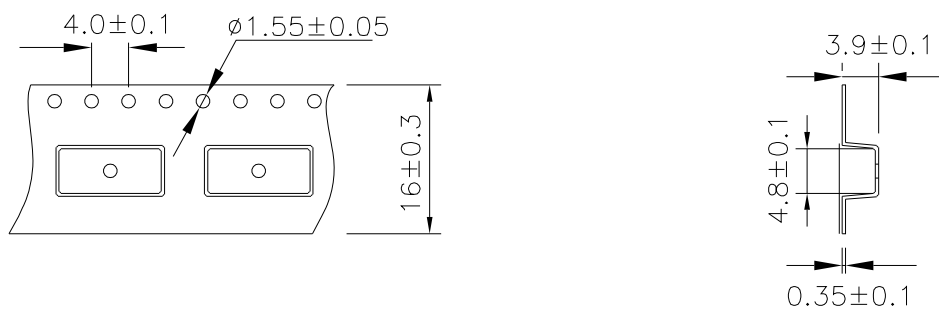
GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them.

RESTRICTIONS ON PRODUCT USE

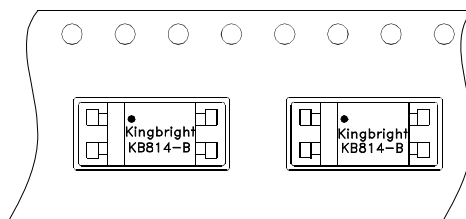
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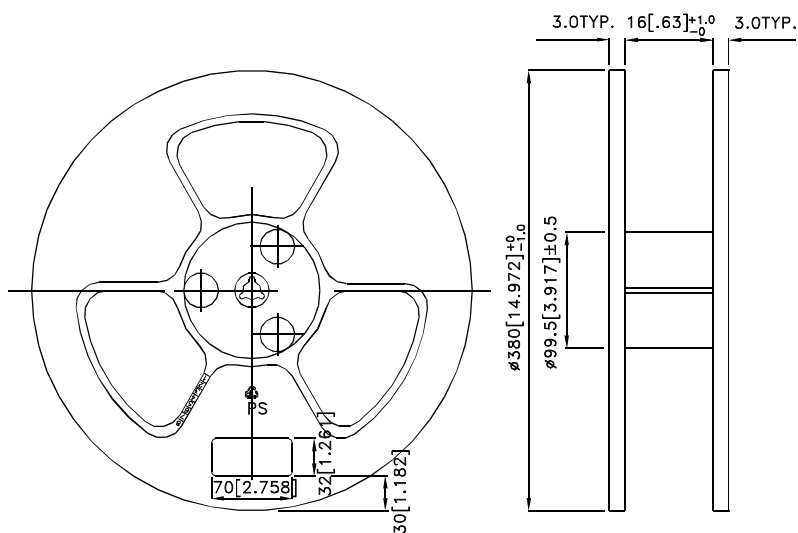
Outline and Dimension (Tape) KB814-B



Tape Direction



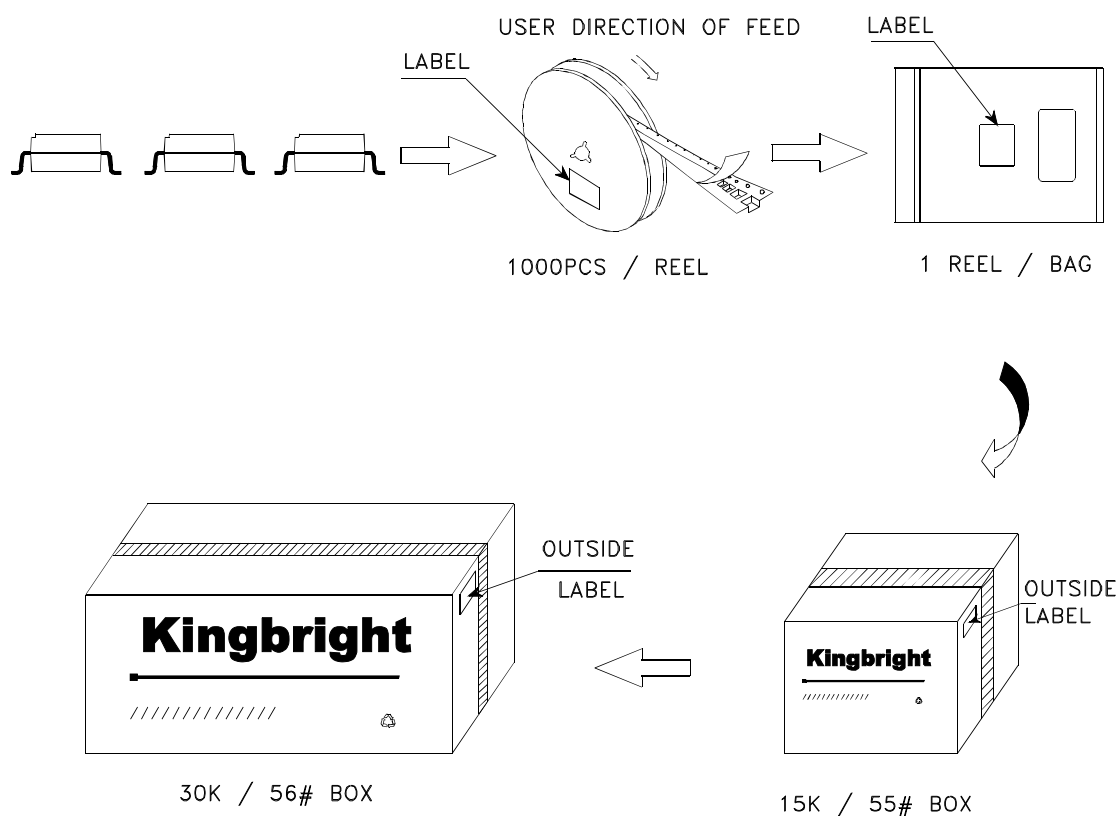
Outline and Dimension(Reel)



Packing: 1000pcs/reel

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PACKING & LABEL SPECIFICATIONS



Kingbright	
P/N0: KB814xxx	
QTY: 1000 pcs	Q.C.
S/N: XXXX	XX XX XXXX PASSED
CODE: XXX	
LOT NO:	
RoHS Compliant	